

T1635H, T1650H

Main characteristics

Symbol	Value	Unit
I _{T(RMS)}	16	A
V _{DRM} /V _{RRM}	600	V
I _{GT}	35 or 50	mA

Features

- Medium current Triac
- 150° C max. T_i turn-off commutation
- Low thermal resistance with clip bonding
- Very high 3 quadrant commutation capability
- Packages are RoHS (2002/95/EC) compliant

Applications

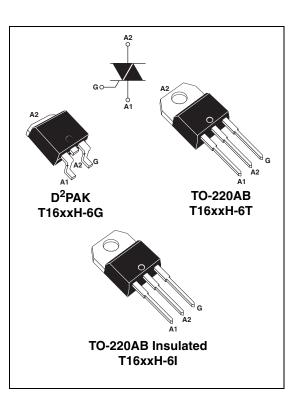
Especially designed to operate in high power density or universal motor applications such as vacuum cleaner and washing machine drum motor, these 16 A triacs provide a very high switching capability up to junction temperatures of 150° C.

The heatsink can be reduced, compared to traditional triacs, according to the high performance at given junction temperatures.

Description

Available in through-hole or surface mount packages, the T1635H and T1650H triac series are suitable for general purpose mains power AC switching.

High temperature 16 A Triacs



Order codes

Part Numbers	Marking
T1635H-6G	T1635H 6G
T1650H-6G	T1650H 6G
T1635H-6G-TR	T1635H 6G
T1650H-6G-TR	T1650H 6G
T1635H-6T	T1635H 6T
T1650H-6T	T1650H 6T
T1635H-6I	T1635H 6I
T1650H-6I	T1650H 6I

May 2007

1 Characteristics

Symbol	Param	Value	Unit				
	PMS on state current (full sine waya)	D ² PAK, TO-220AB $T_c = 130^{\circ} C$				16	А
I _T (RMS)	RMS on-state current (full sine wave)	TO-220AB Ins	TO-220AB lns $T_c = 110^{\circ} C$		A		
1.	Non repetitive surge peak on-state	F = 50 Hz	t = 20 ms	160	А		
ITSM	I_{TSM} current (full cycle, T_j initial = 25° C)		^{ITSM} current (full cycle, T_j initial = 25° C) $F = 60 \text{ Hz}$		t = 16.7 ms	168	A
l ² t	I ² t Value for fusing	t _p = 10 ms	169	A ² s			
dl/dt	Critical rate of rise of on-state current I_G = 2 x I_{GT} , t_r \leq 100 ns	F = 120 Hz	$T_j = 150^\circ C$	50	A/µs		
V _{DSM} /V _{RSM}	Non repetitive surge peak off-state voltage	t _p = 10 ms	$T_j = 25^\circ C$	V _{DRM} /V _{RRM} + 100	V		
I _{GM}	Peak gate current	t _p = 20 μs	$T_j = 150^\circ C$	4	А		
P _{G(AV)}	Average gate power dissipation	1	W				
T _{stg} T _j	Storage junction temperature range Operating junction temperature range	- 40 to + 150 - 40 to + 150	° C				

Table 1. Absolute Maximum Ratings

Table 2.	Electrical Characteristics	$(T_j = 25^{\circ} C)$, unless otl	nerwise spec	cified)

Symbol	Test Conditions Q	Quadrant	Quadrant		Value		
Symbol		Quadrant		T1635H	T1650H	Unit	
I _{GT} ⁽¹⁾	$V_D = 12 V R_L = 33 \Omega$	- -	MAX.	35	50	mA	
V _{GT}	AD = 15 A UT = 22.75	- -	MAX.	1.0	0	V	
V _{GD}	$V_{D} = V_{DRM}, R_{L} = 3.3 \text{ k}\Omega \qquad \qquad I - II - III$		MIN.	0.15		V	
I _H ⁽²⁾	I _T = 500 mA		MAX.	35	75	mA	
1			MAX.	50	90	mA	
ι	$I_{G} = 1.2 I_{GT}$	II	MAA.	80	110	IIIA	
dV/dt ⁽²⁾	$V_D = 67\% V_{DRM,}$ gate open, $T_j = 150^\circ C$		MIN.	1000	1500	V/µs	
(dl/dt)c ⁽²⁾	Without snubber, $T_j = 150^{\circ} C$		MIN.	21	28	A/ms	

1. minimum I_{GT} is guaranted at 20% of I_{GT} max.

2. for both polarities of A2 referenced to A1.

Symbol	Test Conditi	Test Conditions			
V _T ⁽¹⁾	I _{TM} = 23 A, t _p = 380 μs	$T_j = 25^\circ C$	MAX.	1.5	V
V _{t0} ⁽¹⁾	Threshold voltage	T _j = 150° C	MAX.	0.80	V
R_d ⁽¹⁾	Dynamic resistance	T _j = 150° C	MAX.	23	mΩ
		T _j = 25° C	MAX.	5	μA
I _{DRM}	$V_{DRM} = V_{RRM}$	T _j = 150° C	MAX.	4.1	
I _{RRM} ⁽²⁾	$V_D/V_R = 400 V$ (at peak mains voltage)	T _j = 150° C	MAX.	3.5	mA
	$V_D/V_R = 200 V$ (at peak mains voltage)	T _j = 150° C	MAX.	3.0	1

Table 3.Static Characteristics

1. for both polarities of A2 referenced to A1

2. $t_p = 380 \ \mu s$.

Table 4.Thermal resistance

Symbol		Parameter			Unit
P	kunstion to soos (AC)		D ² PAK / TO-220AB	1.15	
R _{th(j-c)}	Junction to case (AC)		TO-220AB Ins	3.1	° C/W
D	lupation to ambient	$S = 1 \text{ cm}^2$	D ² PAK	45	C/W
⊓th(j-a)	R _{th(j-a)} Junction to ambient	L	TO-220AB / TO-220AB Ins	60	

Figure 1. Maximum power dissipation versus Figure 2. RMS on-state current (full cycle)

RMS on-state current versus case temperature (full cycle)

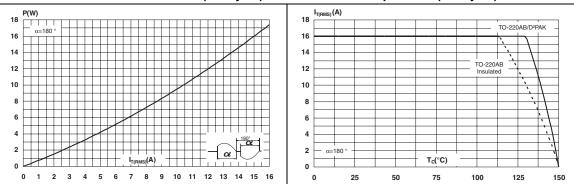
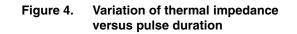




Figure 3. RMS on-state current versus ambient temperature (Epoxy printed circuit board FR4, copper thickness = 35 µm)



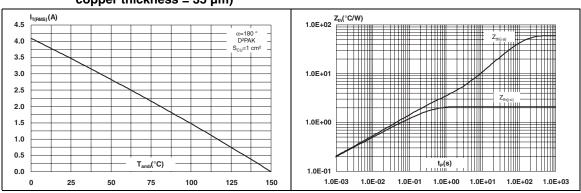


Figure 5. On-state characteristics (maximum Figure 6. Surge peak on-state current versus values) number of cycles

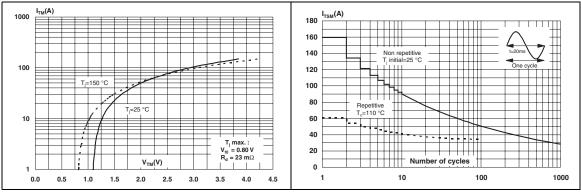
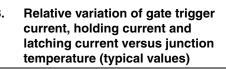
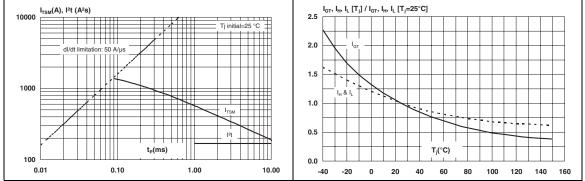


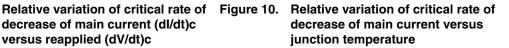
Figure 7. Non-repetitive surge peak on-state Figure 8. current for a sinusoidal pulse with width $t_p < 10$ ms and corresponding value of l^2t

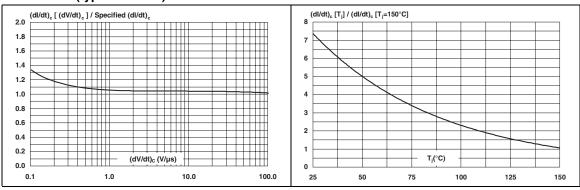




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Figure 9. decrease of main current (dl/dt)c versus reapplied (dV/dt)c (typical values)





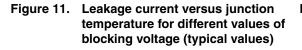
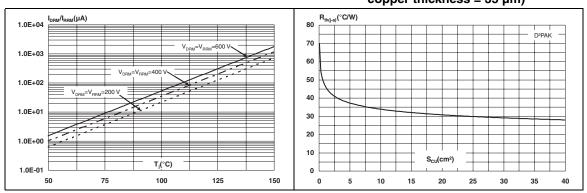


Figure 12. Variation of thermal resistance junction to ambient versus copper surface under tab (Epoxy printed circuit board FR4, copper thickness = 35 µm)



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2 Ordering information

	T 16 xx H - 6 y -TR
Triac series	
Current	
16 = 16 A	
Sensitivity	
35 = 35 mA	
50 = 50 mA	
High temperature	
Voltage	
6 = 600 V	
Package	
$G = D^2 PAK$	
T = TO-220AB	
I = TO-220AB Ins	
Packing	
Blank = Tube (D ² PAK, TO-220AB)	

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3 Package mechanical data

- Epoxy meets UL94, V0
- Recommended torque 0.4 to 0.6 Nm

Table 5. D²PAK dimensions

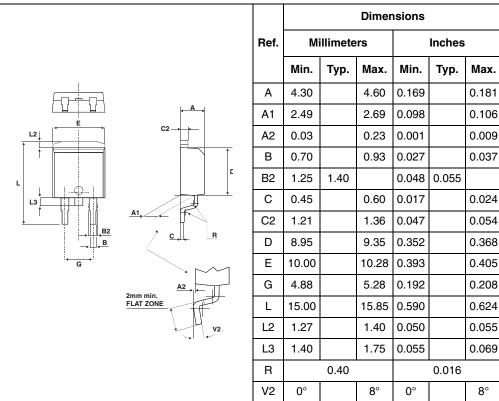
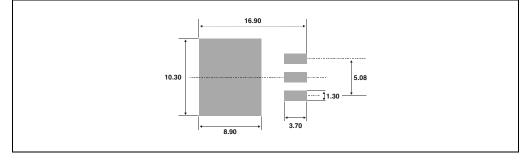


Figure 13. Footprint (dimensions in mm)



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					Dimer	nsions		
		Ref.	Mi	illimete	rs		Inches	
			Min.	Тур.	Max.	Min.	Тур.	Max.
		А	15.20		15.90	0.598		0.625
		a1		3.75			0.147	
Ø I	b2	a2	13.00		14.00	0.511		0.551
		В	10.00		10.40	0.393		0.409
	F	b1	0.61		0.88	0.024		0.034
A		b2	1.23		1.32	0.048		0.051
14 I3 ·		С	4.40		4.60	0.173		0.181
	c2	c1	0.49		0.70	0.019		0.027
+ 12		c2	2.40		2.72	0.094		0.107
a2		е	2.40		2.70	0.094		0.106
	M ←→ c1	F	6.20		6.60	0.244		0.259
e → b1	← c1	ØI	3.75		3.85	0.147		0.151
		14	15.80	16.40	16.80	0.622	0.646	0.661
		L	2.65		2.95	0.104		0.116
		12	1.14		1.70	0.044		0.066
		13	1.14		1.70	0.044		0.066
		М		2.60			0.102	

Table 6. TO-22	0AB and TO-220AB In	s dimensions
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In order to meet environmental requirements, ST offers these devices in ECOPACK® packages. These packages have a Lead-free second level interconnect . The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an ST trademark. ECOPACK specifications are available at: www.st.com.

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4 Ordering Information

Ordering type	Marking	Package	Weight	Base qty	Delivery mode
T16xxH-6G	T16xxH 6G	D ² PAK	1.5 g	50	Tube
T16xxH-6G-TR	T16xxH 6G	D ² PAK	1.5 g	1000	Tape and reel
T16xxH-6T	T16xxH 6T	TO-220AB	2.3 g	50	Tube
T16xxH-6l	T16xxH 6l	TO-220AB Ins	2.3 g	50	Tube

5 Revision history

Date	Revision	Description of Changes
29-May-2007	1	First issue



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